

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6701635

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
RAYMOND ALEXANDER	03/09/2021
NEIL BURNS	04/06/2021
DEREK PUNCH	04/10/2021
NORMAN HIMAKA	05/04/2021
JAMES BECKWITH	03/16/2021
DAVE HENRY	03/21/2021
JOSHUA BRITTON	03/17/2021
FRANCIS PEARCE	03/26/2021
MICHAEL HARRINGTON	03/09/2021
PAUL SITHIDETH	03/17/2021
RECEIVING PARTY DATA	
Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714
PROPERTY NUMBERS Total: 2	
Property Type	Number
Application Number:	17194171
Application Number:	63058361
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	qualcomm-pto@lozaip.com
Correspondent Name:	LOZA & LOZA, LLP/QUALCOMM
Address Line 1:	305 NORTH SECOND AVE., # 127
Address Line 4:	UPLAND, CALIFORNIA 91726
ATTORNEY DOCKET NUMBER:	QCOM-4297US (206199)

NAME OF SUBMITTER:	JULIO LOZA
SIGNATURE:	/Julio Loza/
DATE SIGNED:	05/10/2021
Total Attachments: 15 source=206199_Assignment_signed_filed_05-10-2021_#page1.tif source=206199_Assignment_signed_filed_05-10-2021_#page2.tif source=206199_Assignment_signed_filed_05-10-2021_#page3.tif source=206199_Assignment_signed_filed_05-10-2021_#page4.tif source=206199_Assignment_signed_filed_05-10-2021_#page5.tif source=206199_Assignment_signed_filed_05-10-2021_#page6.tif source=206199_Assignment_signed_filed_05-10-2021_#page7.tif source=206199_Assignment_signed_filed_05-10-2021_#page8.tif source=206199_Assignment_signed_filed_05-10-2021_#page9.tif source=206199_Assignment_signed_filed_05-10-2021_#page10.tif source=206199_Assignment_signed_filed_05-10-2021_#page11.tif source=206199_Assignment_signed_filed_05-10-2021_#page12.tif source=206199_Assignment_signed_filed_05-10-2021_#page13.tif source=206199_Assignment_signed_filed_05-10-2021_#page14.tif source=206199_Assignment_signed_filed_05-10-2021_#page15.tif	

ASSIGNMENT

WHEREAS, WE,

1. **Raymond ALEXANDER**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
2. **Neil BURNS**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
3. **Derek PUNCH**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
4. **Norman HIMAKA**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
5. **James BECKWITH**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
6. **Dave HENRY**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
7. **Joshua BRITTON**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
8. **Francis PEARCE**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
9. **Michael HARRINGTON**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,
10. **Paul SITHIDETH**, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714,

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **MOBILE DEVICE POSITIONER AND CONFIGURABLE MOBILE DEVICE HOLDER** (collectively the “**INVENTIONS**”) for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, **QUALCOMM Incorporated** (hereinafter “**ASSIGNEE**”), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to

said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to **U.S. Application No. 17/194,171, filed March 5, 2021, Qualcomm Reference Number 206199**, and all provisional applications relating thereto, together with **U.S Provisional Application No(s). 63/058,361, filed July 29, 2020, Qualcomm Reference Number 206199P1**, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date **Raymond ALEXANDER**

Done at _____, on _____
City, State, Country Date **Neil BURNS**

Done at _____, on _____
City, State, Country Date **Derek PUNCH**

Done at _____, on _____
City, State, Country Date **Norman HIMAKA**

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date **James BECKWITH**

Done at _____, on _____
City, State, Country Date **Dave HENRY**

Done at _____, on _____
City, State, Country Date **Joshua BRITTON**

Done at _____, on _____
City, State, Country Date **Francis PEARCE**

Done at _____, on _____
City, State, Country Date **Michael HARRINGTON**

AND WE HEREBY covenant that WE will not execute any writing or do any act
whatsoever conflicting with these presents.


Done at _____, on _____
City, State, Country Date **Paul SITHIDETH**

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at SAN DIEGO, CA, on 3/9/21
City, State, Country Date


Raymond ALEXANDER

Done at _____, on _____
City, State, Country Date

Neil BURNS

Done at _____, on _____
City, State, Country Date

Derek PUNCH

Done at _____, on _____
City, State, Country Date

Norman HIMAKA

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date Raymond ALEXANDER

Done at SAN DIEGO, CA, on 04/06/2021
City, State, Country Date Neil BURNS
USA

Done at _____, on _____
City, State, Country Date Derek PUNCH

Done at _____, on _____
City, State, Country Date Norman HIMAKA

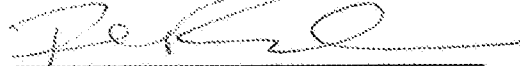
ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date Raymond ALEXANDER

Done at _____, on _____
City, State, Country Date Neil BURNS

Done at _____, on 4/10/21
City, State, Country Date 
Derek PUNCH

Done at _____, on _____
City, State, Country Date Norman HIMAKA

ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date Raymond ALEXANDER

Done at _____, on _____
City, State, Country Date Neil BURNS

Done at _____, on _____
City, State, Country Date Derek PUNCH

Done at San Diego, CA USA, on 5/4/2021
City, State, Country Date Norman Himaka
Norman HIMAKA

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at SAN DIEGO, CA, on 3-16-21
City, State, Country Date

James Beckwith
James BECKWITH

Done at _____, on _____
City, State, Country Date

Dave HENRY

Done at _____, on _____
City, State, Country Date

Joshua BRITTON

Done at _____, on _____
City, State, Country Date

Francis PEARCE

Done at _____, on _____
City, State, Country Date

Michael HARRINGTON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date

James BECKWITH

Done at San Diego, CA
USA, on 3/21/21
City, State, Country Date

Dave HENRY

Done at _____, on _____
City, State, Country Date

Joshua BRITTON

Done at _____, on _____
City, State, Country Date

Francis PEARCE

Done at _____, on _____
City, State, Country Date

Michael HARRINGTON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date James BECKWITH

Done at _____, on _____
City, State, Country Date Dave HENRY

Done at San Diego, CA, USA, on 03-17-2021
City, State, Country Date Joshua BRITTON

Done at _____, on _____
City, State, Country Date Francis PEARCE

Done at _____, on _____
City, State, Country Date Michael HARRINGTON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date James BECKWITH

Done at _____, on _____
City, State, Country Date Dave HENRY

Done at _____, on _____
City, State, Country Date Joshua BRITTON

Done at _____, on 3/26/21
City, State, Country Date Francis PEARCE

Done at _____, on _____
City, State, Country Date Michael HARRINGTON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at _____, on _____
City, State, Country Date James BECKWITH

Done at _____, on _____
City, State, Country Date Dave HENRY

Done at _____, on _____
City, State, Country Date Joshua BRITTON

Done at _____, on _____
City, State, Country Date Francis PEARCE

Done at San Diego, CA, USA, on 3/9/2021
City, State, Country Date  Michael HARRINGTON

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

San Diego, CA, USA
Done at _____, on 3/17/21
City, State, Country Date



Paul SITHIDETH